TOSHIBA SHR400EX25

TOSHIBA ALLOY-FREE REVERSE CONDUCTING THYRISTOR

SHR400EX25

HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage $: V_{DRM} = 2500V$

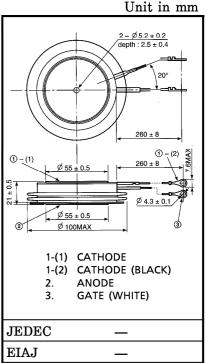
R.M.S On-State Current $: I_{T(RMS)} = 630A$

Turn-Off Time : $t_0 = 40 \mu s$ (Max.)

Flat Package

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage	$v_{ m DRM}$	2500	V	
Non-Repetitive Peak Off-State Voltage (Non-Repetitive $< 5 \text{ms}$, $T_j = 0 \sim 115$ °C)	$v_{ m DSM}$	2500	V	
R.M.S On-State Current	I _T (RMS)	630	A	
R.M.S Reverse Current	I _R (RMS)	235		
Average On-State Current	I _{T (AV)}	400	A	
Average Reverse Current	I _{R (AV)}	150		
Peak One Cycle Surge On-State		7000 (50Hz)	A	
Current (Non-Repetitive)	ITSM	7700 (60Hz)		
Peak One Cycle Surge Reverse	Incur	2500 (50Hz)		
Current (Non-Repetitive)	I_{RSM}	2750 (60Hz)		
I ² t Limit Value	I ² t	245×10^{3} (On-Current) 31×10^{3} (Reverse Current)	$ m A^2s$	
Critical Rate of Rise of On-State Current	di / dt	200	A/μs	
Peak Gate Power Dissipation	P_{GM}	20	W	
Average Gate Power Dissipation	P _G (AV)	4	W	
Peak Forward Gate Current	I_{GM}	4	Α	
Peak Forward Gate Voltage	v_{FGM}	20	V	
Peak Reverse Gate Voltage	$v_{ m RGM}$	5	V	
Junction Temperature	T_{j}	-40~115	$^{\circ}\mathrm{C}$	
Storage Temperature Range	$ m T_{stg}$	-40~115	°C	
Mounting Force	_	19.6±2	kN	



Weight: 630g (Typ.)

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ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current	$I_{ m DRM}$	V _{DRM} =Rated, T _j =115°C		_	100	mA
Peak On-State Voltage	$V_{ extbf{TM}}$	$I_{TM} = 1250A, T_j = 25^{\circ}C$		_	3.0	3.7
Peak Reverse Voltage	$v_{ m RM}$	$I_{RM} = 500A, T_j = 25^{\circ}C$		_	2.3	V
Gate Trigger Voltage	$v_{ m GT}$	$V_D=12V, R_L=6\Omega$	$T_j = -40^{\circ}C$	— 0.5	4.0 3.0	v
			$\begin{array}{ c c }\hline T_j = 25^{\circ}C \\\hline T_j = -40^{\circ}C \\\hline \end{array}$	— —	500	mA
Gate Trigger Current	$_{ m IGT}$		$T_i = 25$ °C	15	300	
Gate Non-Trigger Voltage	$v_{ m GD}$	V_D =0.5 Rated, T_j =115°C		0.2	_	V
Gate Non-Trigger Current	I_{GD}			5	_	mA
Delay Time	^t d	V _D =0.5 Rated, T _j =25°C,		_	4	μs
Gate Turn-On Time	tgt	Gate Supply ($V_G=15V$, $R_G=8\Omega$, $t_r \le 1\mu s$) di/dt=200A/ μs		_	6	μs
Turn-Off Time	$\mathbf{t_q}$	I_{TM} =400A, I_{R} =10A V_{DRM} =0.5 Rated dv/dt =350V/ μ s, T_{j} =115°C		_	40	μs
Holding Current	I_{H}	$T_j=25$ °C, $R_L=6\Omega$		_	1000	mA
Critical Rate of Rise of Commutating OFF-State Voltage	dv / dt (C)	I_{TM} =2500A, I_{RM} =2500A, V_{DRM} =0.5 Rated, Pulse width=100 μ s, T_j =115°C		350	_	V/μs
Thermal Resistance (Junction to Case)	R _{th (j-f)}	DC		_	0.025	°C/W